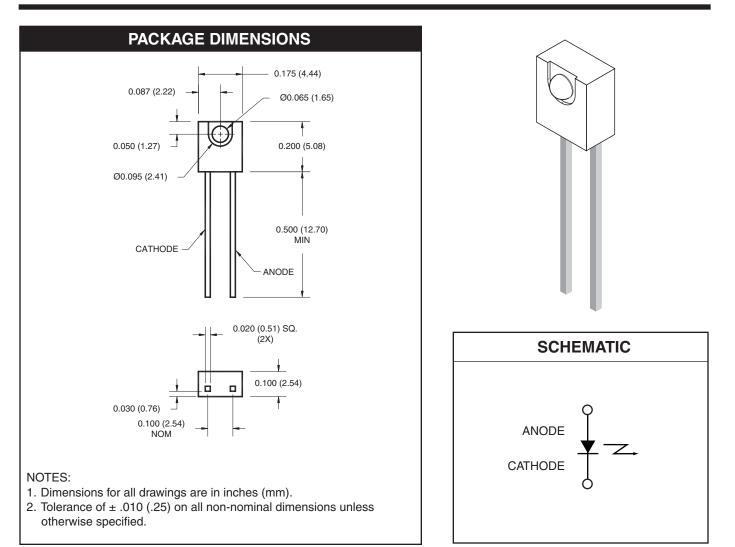


PLASTIC INFRARED LIGHT EMITTING DIODE

QEE122 QEE123



DESCRIPTION

The QEE12X is a 880 nm AlGaAs LED encapsulated in a medium wide angle, plastic sidelooker package.

FEATURES

- λ= 880 nm
- Package Type = Sidelooker
- Chip Material = AlGaAs
- Matched Photosensor: QSE113
- Medium Wide Emission Angle, 50°
- Package Material: Clear Epoxy
- High Output Power
- Orange stripe on the top side



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ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)								
Parameter	Symbol	Rating	Unit					
Operating Temperature	T _{OPR}	-40 to + 100	°C					
Storage Temperature	T _{STG}	-40 to + 100	°C					
Soldering Temperature (Iron) ^(2,3,4)	T _{SOL-I}	240 for 5 sec	°C					
Soldering Temperature (Flow) ^(2,3)	T _{SOL-F}	260 for 10 sec	°C					
Continuous Forward Current	١ _F	50	mA					
Reverse Voltage	V _R	5	V					
Power Dissipation ⁽¹⁾	P _D	100	mW					

NOTES:

1. Derate power dissipation linearly 1.33 mW/°C above 25°C.

2. RMA flux is recommended.

3. Methanol or isopropyl alcohols are recommended as cleaning agents.

4. Soldering iron 1/16" (1.6 mm) minimum from housing

ELECTRICAL / OPTICAL CHARACTERISTICS (T _A =25°C)								
Parameter	Test Conditions	Symbol	Min	Тур	Max	Units		
Peak Emission Wavelength	I _F = 100 mA	λ _{PE}		940	_	nm		
Emission Angle	I _F = 100 mA	201/2	_	50	—	Deg.		
Forward Voltage	I _F = 100 mA, tp = 20 ms	V _F	_	_	1.7	V		
Reverse Current	V _R = 5 V	I _R	_	_	10	μA		
Radiant Intensity QEE122	I _F = 100 mA, tp = 20 ms	١ _E	4	_	16	mW/sr		
Radiant Intensity QEE123	I _F = 100 mA, tp = 20 ms	١ _E	8	_	—	mW/sr		
Rise Time	- I _F = 100 mA	t _r	—	800	—	ns		
Fall Time		t _f	_	800	_	ns		



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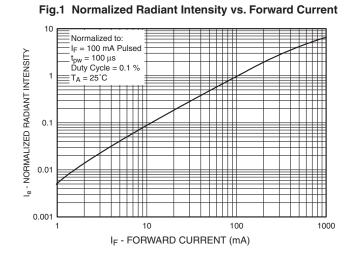


Fig.2 Coupling Characteristics of QEE123 And QSE113

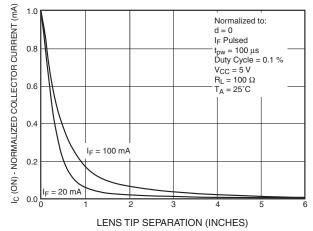
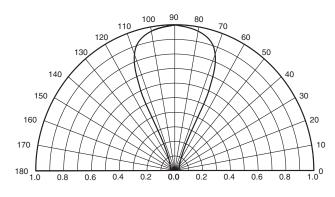


Fig. 4 Normalized Intensity vs. Wavelength

Fig.3 Forward Voltage vs. Ambient Temperature

2.0 1.0 $I_{F} = 50 \text{ mA}$ 0.9 NORMALIZED RADIANT INTENSITY I_F = 100 mA 0.8 VF - FORWARD VOLTAGE (V) 1.5 0.7 0.6 I_F = 10 mA I_F = 20 mA 0.5 1.0 0.4 0.3 0.5 Normalized to: 0.2 I_F Pulsed t_{pw} = 100 μs Duty Cycle = 0.1 % 0.1 0.0 775 800 825 850 875 900 925 950 -40 -20 0 20 40 60 80 100 λ (nm) TA - AMBIENT TEMPERATURE (°C)

Fig. 5 Radiation Diagram





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QEE122 QEE123

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